

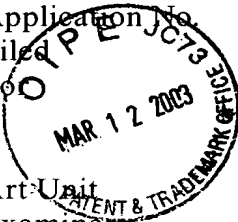
2826  
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## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of

Applicant : Chao-Fu Weng  
Application No. : 10/065,632  
Filed : November 05, 2002  
For : CHIP STRUCTURE WITH BUMPS AND A PROCESS  
FOR FABRICATING THE SAME

Art Unit : 2826  
Examiner : GREENE, PERSHELLE L

#4/Eo/Am2  
Election  
Amend A  
Answer  
3/25/03RESPONSE TO RESTRICTION REQUIREMENT**BOX Amendment**

Assistant Commissioner for Patents  
Washington D.C. 20231

Dear Sirs:

In response to the Restriction Requirement mailed on January 28, 2003 regarding the above-identified application, applicant elects Group II, claims 15-20, for further examination on merits.

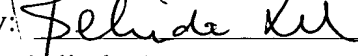
Please cancel claims 1-14 without prejudice and disclaimer.

A Credit Card Payment Form in the amount of \$110 covering the one-month extension fee is enclosed herewith.

Respectfully Submitted,  
JIANQ CHYUN Intellectual Property

Office

Dated: March 7, 2003

By:   
Belinda Lee  
Registration No.: 46,863

Please send future correspondence to:  
7F.-1, No. 100, Roosevelt Rd.,  
Sec. 2, Taipei 100, Taiwan, R.O.C.  
Tel: 886-2-2369 2800  
Fax: 886-2-2369 7233 / 886-2-2369 7234

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